IN THE SPECIFICATION

Please replace the paragraph beginning at page 22, line 20, with the following rewritten paragraph:

As shown in Fig. 1, the optical scan module 101 has two holes 410-1 and 410-2 formed in the cap 410 along the principal scan direction x. As shown in Fig. 3, in an assembly process for positioning the optical scan module 101 on he the circuit substrate 104, pins 1 and 1b provided on a hand of an assembly robot are inserted into the holes 410-1 and 410-2, to push the optical scan module 101 onto the circuit substrate 104, while moving for position.

Please replace the paragraph beginning at page 40, line 19, with the following rewritten paragraph:

The light beam from the second reflection unit 214 is projected out of the projection window 215, toward the surface to be scanned. The electrode substrate 31, silicon substrate 33, frame 212, and sealing plate 214 216 are laminated in order and joined together to constitute the optical scan module 801.

2